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**MAR 08 2006**


**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In Re Application of:	)	
	)	
Hsin-Hui Lee	)	Group Art Unit: 2841
	)	
Serial No.: 10/781,169	)	Examiner: Patel, Ishwarbhai B.
	)	
Filed: February 18, 2004	)	Confirmation No.: 1798
	)	
For: Underfilling Efficiency By Modifying the	)	TKHR Docket: 252016-2790
Substrate Design of Flip Chips	)	Top-Team: 0503-A30788US
	)	

**CERTIFICATE OF FACSIMILE TRANSMISSION UNDER 37 CFR §1.8**

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March 8, 2006  
Date

  
Daniel R. McClure

**AMENDMENT AND RESPONSE TO OFFICE ACTION**

Mail Stop Amendment  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

The Office Action mailed December 16, 2005 has been carefully considered. In response thereto, please enter the following amendments and consider the following remarks.